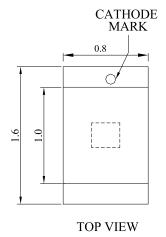
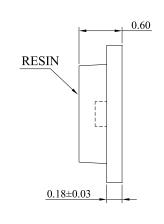
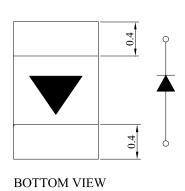
multicomp PRO

Package Dimensions:

RoHS Compliant







All dimensions are in mm Tolerance: ±0.1mm

Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Rating	Unit
Power Dissipation	PD	78	°C
Reverse Voltage	VR	5	V
D.C. Forward Current	If	30	mA
Pulsed Forward Current (1 / 10 Duty Cycle, 0.1ms Pulse Width)	If (Peak)	80	mA
Operating Temperature Range	Topr.	-40 to +80	°C
Storage Temperature Range	Tstg.	-40 to +85	°C
Soldering Temperature	Tsld.	Reflow Soldering: 260°C for 10sec.	

Electrical & Optical Characteristics: Hyper Red

•	7.					
Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
Luminous Intensity	lv	If = 20mA	-	11	-	mcd
Forward Voltage	Vf	If = 20mA	1.9	-	2.6	V
Peak Wavelength	λр	If = 20mA	-	630	-	nm
Dominent Wavelength	λd	If = 20mA	-	625	-	nm
Reverse Current	lr	Vr = 5V	-	-	100	μA
Viewing Angle	2θ ½	If = 20mA	-	140	-	deg
Spectrum Line Halfwidth	Δλ	If = 20mA	-	35	-	nm

Note: 1. The data is tested by an IS tester

2. Customer's special requirements are also welcome.

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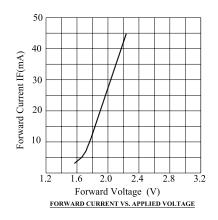


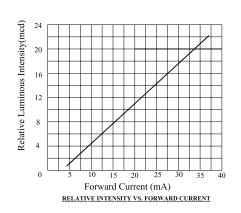
Product Specification

	Specification	Material	Quantity
lv	L: 5.16 – 7.56 mcd M: 7.56 – 11.0 mcd N: 11.0 – 16.5 mcd @ 20mA	-	-
λd	636 – 650 nm @ 20mA	-	-
Vf	H: 1.9 – 2.2 V J: 2.2 2.4 V K: 2.4 – 2.6 V @ 20mA	-	-
Ir	< 100µA @ Vr=5V	-	-
Resin	White diffused	Epoxy resin	-
Carrier tape	-	Conductive black tape	4,000pcs per reel
Reel	-	White	-
Label	LT standard	Paper	-
Packing Bag	250mm × 220mm	Aluminium laminated bag	One reel one bag
Carton	LT standard	Paper	Non-specified

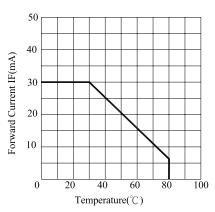
Typical Electrical & Optical Characteristics Curves:

(25°C Ambient temperature unless otherwise noted)

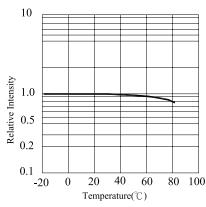




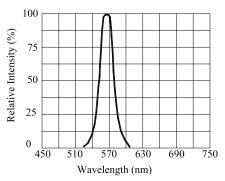




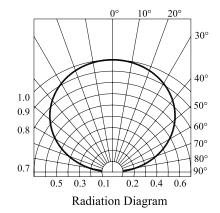
FORWARD CURRENT VS. AMBIENT TEMPERATURE



 $\underline{\textbf{RELATIVE INTENSITY VS. AMBIENT TEMPERATURE}}$



RELATIVE INTENSITY VS. WAVELENGTH



Recommended Storage Environment:

- Temperature: 5°C to 30°C (41°F to 86°F)
- Humidity: 60% RH Max.
- · Use within 7 days after opening of sealed vapour/ESD barrier bags

If moisture absorbent material (silica gel) has faded away or LEDs have exceeded the storage time, baking treatment should be performed using the following conditions:

- Baking Treatment : 60 ± 5°C for 24 hours
- Fold the opened bag firmly and keep in dry environment

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Reflow Soldering

Recommended use of upper and lower heater type reflow furnace.

- 260°C max for up to 10 seconds, one time only
- Pre-heat is 150°C max for up to 2 minutes max
- · In case of screen-printing, keep metal mask thickness between 0.2mm and 0.3mm

Cleaning

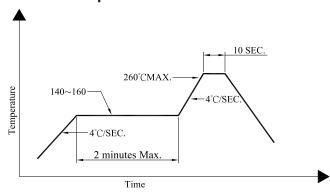
Surface condition of this device may change when organic solvents such as trichloroethylene or acetone were applied.

- · Avoid using organic solvent
- Recommend ultrasonic method 300W max.

Packaging

- · EIA-481A standard package
- In 8mm tape on 4,000pcs diameter reels sealed in vapour/ESD barrier bags

Reflow Temp / Time:



Part Number Table

LED	LED Chip		Part Number	
Material	Emitting Colour	Lens Colour	Part Number	
GaAsP / GaP	Orange	White diffused	703-0111	

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